

SN54LV4051A, SN74LV4051A 8-CHANNEL ANALOG MULTIPLEXERS/DEMULTIPLEXERS

SCLS428F – MAY 1999 – REVISED AUGUST 2003

- 2-V to 5.5-V V_{CC} Operation
- Support Mixed-Mode Voltage Operation on All Ports
- High On-Off Output-Voltage Ratio
- Low Crosstalk Between Switches
- Individual Switch Controls
- Extremely Low Input Current
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- ESD Protection Exceeds JESD 22
 - 2000-V Human-Body Model (A114-A)
 - 200-V Machine Model (A115-A)
 - 1000-V Charged-Device Model (C101)

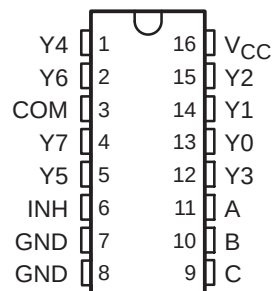
description/ordering information

These 8-channel CMOS analog multiplexers/demultiplexers are designed for 2-V to 5.5-V V_{CC} operation.

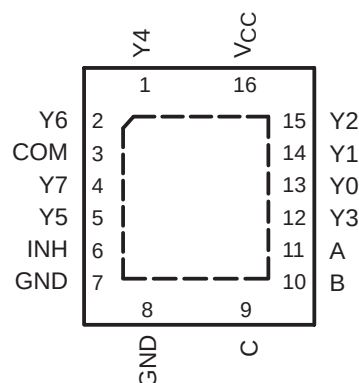
The 'LV4051A devices handle both analog and digital signals. Each channel permits signals with amplitudes up to 5.5 V (peak) to be transmitted in either direction.

Applications include signal gating, chopping, modulation or demodulation (modem), and signal multiplexing for analog-to-digital and digital-to-analog conversion systems.

SN54LV4051A . . . J OR W PACKAGE
SN74LV4051A . . . D, DB, DGV, N, NS, OR PW PACKAGE
(TOP VIEW)



SN74LV4051A . . . RGY PACKAGE
(TOP VIEW)



ORDERING INFORMATION

T_A	PACKAGE [†]		ORDERABLE PART NUMBER	TOP-SIDE MARKING
–40°C to 85°C	PDIP – N	Tube of 25	SN74LV4051AN	SN74LV4051AN
	QFN – RGY	Reel of 1000	SN74LV4051ARGYR	LW051A
	SOIC – D	Tube of 40	SN74LV4051AD	LV4051A
		Reel of 2500	SN74LV4051ADR	
	SOP – NS	Reel of 2000	SN74LV4051ANSR	74LV4051A
	SSOP – DB	Reel of 2000	SN74LV4051ADBR	LW051A
	TSSOP – PW	Tube of 90	SN74LV4051APW	LW051A
		Reel of 2000	SN74LV4051APWR	
		Reel of 250	SN74LV4051APWT	
	TVSOP – DGV	Reel of 2000	SN74LV4051ADGVR	LW051A
–55°C to 125°C	CDIP – J	Tube of 25	SNJ54LV4051AJ	SNJ54LV4051AJ
	CFP – W	Tube of 150	SNJ54LV4051AW	SNJ54LV4051AW

[†] Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

UNLESS OTHERWISE NOTED this document contains PRODUCTION DATA information current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

**TEXAS
INSTRUMENTS**

POST OFFICE BOX 655303 • DALLAS, TEXAS 75265

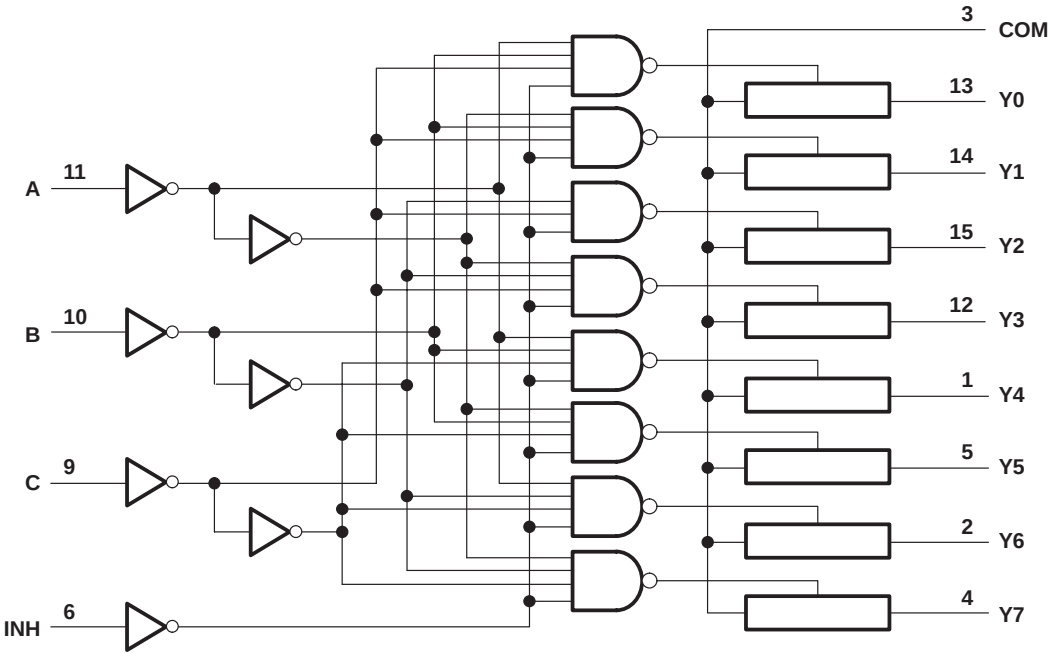
Copyright © 2003, Texas Instruments Incorporated

SN54LV4051A, SN74LV4051A
8-CHANNEL ANALOG MULTIPLEXERS/DEMULTIPLEXERS

SCLS428F – MAY 1999 – REVISED AUGUST 2003

FUNCTION TABLE				
INPUTS				ON CHANNEL
INH	C	B	A	
L	L	L	L	Y0
L	L	L	H	Y1
L	L	H	L	Y2
L	L	H	H	Y3
L	H	L	L	Y4
L	H	L	H	Y5
L	H	H	L	Y6
L	H	H	H	Y7
H	X	X	X	None

logic diagram (positive logic)



SN54LV4051A, SN74LV4051A

8-CHANNEL ANALOG MULTIPLEXERS/DEMULTIPLEXERS

SCLS428F – MAY 1999 – REVISED AUGUST 2003

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage range, V_{CC}	–0.5 V to 7.0 V
Input voltage range, V_I (see Note 1)	–0.5 V to 7.0 V
Switch I/O voltage range, V_{IO} (see Notes 1 and 2)	–0.5 V to $V_{CC} + 0.5$ V
Input clamp current, I_{IK} ($V_I < 0$)	–20 mA
I/O diode current, I_{IOK} ($V_{IO} < 0$ or $V_{IO} > V_{CC}$)	±50 mA
Switch through current, I_T ($V_{IO} = 0$ to V_{CC})	±25 mA
Continuous current through V_{CC} or GND	±50 mA
Package thermal impedance, θ_{JA} (see Note 3): D package	73°C/W
(see Note 3): DB package	82°C/W
(see Note 3): DGV package	120°C/W
(see Note 3): N package	67°C/W
(see Note 3): NS package	64°C/W
(see Note 3): PW package	108°C/W
(see Note 4): RGY package	39°C/W
Storage temperature range, T_{stg}	–65°C to 150°C

[†] Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES:
1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.
 2. This value is limited to 5.5 V maximum.
 3. The package thermal impedance is calculated in accordance with JESD 51-7.
 4. The package thermal impedance is calculated in accordance with JESD 51-5.

recommended operating conditions (see Note 5)

		SN54LV4051A		SN74LV4051A		UNIT
		MIN	MAX	MIN	MAX	
V_{CC}	Supply voltage	2 [‡]	5.5	2 [‡]	5.5	V
V_{IH}	High-level input voltage, control inputs	$V_{CC} = 2$ V	1.5	1.5		V
		$V_{CC} = 2.3$ V to 2.7 V	$V_{CC} \times 0.7$	$V_{CC} \times 0.7$		
		$V_{CC} = 3$ V to 3.6 V	$V_{CC} \times 0.7$	$V_{CC} \times 0.7$		
		$V_{CC} = 4.5$ V to 5.5 V	$V_{CC} \times 0.7$	$V_{CC} \times 0.7$		
V_{IL}	Low-level input voltage, control inputs	$V_{CC} = 2$ V	0.5	0.5		V
		$V_{CC} = 2.3$ V to 2.7 V	$V_{CC} \times 0.3$	$V_{CC} \times 0.3$		
		$V_{CC} = 3$ V to 3.6 V	$V_{CC} \times 0.3$	$V_{CC} \times 0.3$		
		$V_{CC} = 4.5$ V to 5.5 V	$V_{CC} \times 0.3$	$V_{CC} \times 0.3$		
V_I	Control input voltage	0	5.5	0	5.5	V
V_{IO}	Input/output voltage	0	V_{CC}	0	V_{CC}	V
$\Delta t/\Delta v$	Input transition rise or fall rate	$V_{CC} = 2.3$ V to 2.7 V	200	200		ns/V
		$V_{CC} = 3$ V to 3.6 V	100	100		
		$V_{CC} = 4.5$ V to 5.5 V	20	20		
T_A	Operating free-air temperature	–55	125	–40	85	°C

[‡] With supply voltages at or near 2 V, the analog switch on-state resistance becomes very nonlinear. It is recommended that only digital signals be transmitted at these low supply voltages.

NOTE 5: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to TI application report *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

SN54LV4051A, SN74LV4051A

8-CHANNEL ANALOG MULTIPLEXERS/DEMULTIPLEXERS

SCLS428F – MAY 1999 – REVISED AUGUST 2003

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	V _{CC}	T _A = 25°C			SN54LV4051A		SN74LV4051A		UNIT
			MIN	TYP	MAX	MIN	MAX	MIN	MAX	
r _{on} On-state switch resistance	I _T = 2 mA, V _I = V _{CC} or GND, V _{INH} = V _{IL} (see Figure 1)	2.3 V		38	180		225		225	Ω
		3 V		30	150		190		190	
		4.5 V		22	75		100		100	
r _{on(p)} Peak on-state resistance	I _T = 2 mA, V _I = V _{CC} to GND, V _{INH} = V _{IL}	2.3 V		113	500		600		600	Ω
		3 V		54	180		225		225	
		4.5 V		31	100		125		125	
Δr _{on} Difference in on-state resistance between switches	I _T = 2 mA, V _I = V _{CC} to GND, V _{INH} = V _{IL}	2.3 V		2.1	30		40		40	Ω
		3 V		1.4	20		30		30	
		4.5 V		1.3	15		20		20	
I _I Control input current	V _I = 5.5 V or GND	0 to 5.5 V			±0.1		±1		±1	μA
I _{S(off)} Off-state switch leakage current	V _I = V _{CC} and V _O = GND, or V _I = GND and V _O = V _{CC} , V _{INH} = V _{IH} (see Figure 2)	5.5 V			±0.1		±1		±1	μA
I _{S(on)} On-state switch leakage current	V _I = V _{CC} or GND, V _{INH} = V _{IL} (see Figure 3)	5.5 V			±0.1		±1		±1	μA
I _{CC} Supply current	V _I = V _{CC} or GND	5.5 V					20		20	μA
C _{IC} Control input capacitance	f = 10 MHz	3.3 V		2						pF
C _{IS} Common terminal capacitance		3.3 V		23.4						pF
C _{OS} Switch terminal capacitance		3.3 V		5.7						pF
C _F Feedthrough capacitance		3.3 V		0.5						pF

switching characteristics over recommended operating free-air temperature range, V_{CC} = 2.5 V ± 0.2 V (unless otherwise noted)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	T _A = 25°C			SN54LV4051A		SN74LV4051A		UNIT
				MIN	TYP	MAX	MIN	MAX	MIN	MAX	
t _{PLH} Propagation delay time	COM or Y _n	Y _n or COM	C _L = 15 pF, (see Figure 4)		1.9	10		16		16	ns
t _{PZH} Enable delay time	INH	COM or Y _n	C _L = 15 pF, (see Figure 5)		6.6	18		23		23	ns
t _{PHZ} Disable delay time	INH	COM or Y _n	C _L = 15 pF, (see Figure 5)		7.4	18		23		23	ns
t _{PLH} Propagation delay time	COM or Y _n	Y _n or COM	C _L = 50 pF, (see Figure 5)		3.8	12		18		18	ns
t _{PZH} Enable delay time	INH	COM or Y _n	C _L = 50 pF, (see Figure 5)		7.8	28		35		35	ns
t _{PHZ} Disable delay time	INH	COM or Y _n	C _L = 50 pF, (see Figure 5)		11.5	28		35		35	ns

PRODUCT PREVIEW information concerns products in the formative or design phase of development. Characteristic data and other specifications are design goals. Texas Instruments reserves the right to change or discontinue these products without notice.



POST OFFICE BOX 655303 • DALLAS, TEXAS 75265

SN54LV4051A, SN74LV4051A

8-CHANNEL ANALOG MULTIPLEXERS/DEMULTIPLEXERS

SCLS428F – MAY 1999 – REVISED AUGUST 2003

**switching characteristics over recommended operating free-air temperature range,
V_{CC} = 3.3 V ± 0.3 V (unless otherwise noted)**

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	T _A = 25°C			SN54LV4051A		SN74LV4051A		UNIT
				MIN	TYP	MAX	MIN	MAX	MIN	MAX	
t _{PLH} t _{PHL}	Propagation delay time	COM or Y _n	Y _n or COM	C _L = 15 pF, (see Figure 4)			1.2		6		ns
t _{PZH} t _{PZL}	Enable delay time	INH	COM or Y _n	C _L = 15 pF, (see Figure 5)			4.7		12		ns
t _{PHZ} t _{PLZ}	Disable delay time	INH	COM or Y _n	C _L = 15 pF, (see Figure 5)			5.7		12		ns
t _{PLH} t _{PHL}	Propagation delay time	COM or Y _n	Y _n or COM	C _L = 50 pF, (see Figure 4)			2.5		9		ns
t _{PZH} t _{PZL}	Enable delay time	INH	COM or Y _n	C _L = 50 pF, (see Figure 5)			5.5		20		ns
t _{PHZ} t _{PLZ}	Disable delay time	INH	COM or Y _n	C _L = 50 pF, (see Figure 5)			8.8		20		ns

**switching characteristics over recommended operating free-air temperature range,
V_{CC} = 5 V ± 0.5 V (unless otherwise noted)**

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	T _A = 25°C			SN54LV4051A		SN74LV4051A		UNIT
				MIN	TYP	MAX	MIN	MAX	MIN	MAX	
t _{PLH} t _{PHL}	Propagation delay time	COM or Y _n	Y _n or COM	C _L = 15 pF, (see Figure 4)			0.6		4		ns
t _{PZH} t _{PZL}	Enable delay time	INH	COM or Y _n	C _L = 15 pF, (see Figure 5)			3.5		8		ns
t _{PHZ} t _{PLZ}	Disable delay time	INH	COM or Y _n	C _L = 15 pF, (see Figure 5)			4.4		8		ns
t _{PLH} t _{PHL}	Propagation delay time	COM or Y _n	Y _n or COM	C _L = 50 pF, (see Figure 4)			1.5		6		ns
t _{PZH} t _{PZL}	Enable delay time	INH	COM or Y _n	C _L = 50 pF, (see Figure 5)			4		14		ns
t _{PHZ} t _{PLZ}	Disable delay time	INH	COM or Y _n	C _L = 50 pF, (see Figure 5)			6.2		14		ns

PRODUCT PREVIEW information concerns products in the formative or design phase of development. Characteristic data and other specifications are design goals. Texas Instruments reserves the right to change or discontinue these products without notice.



POST OFFICE BOX 655303 • DALLAS, TEXAS 75265

SN54LV4051A, SN74LV4051A
8-CHANNEL ANALOG MULTIPLEXERS/DEMULTIPLEXERS

SCLS428F – MAY 1999 – REVISED AUGUST 2003

analog switch characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	V _{CC}	T _A = 25°C			UNIT
					MIN	TYP	MAX	
Frequency response (switch on)	COM or Y _n	Y _n or COM	C _L = 50 pF, R _L = 600 Ω, f _{in} = 1 MHz (sine wave) (see Note 6 and Figure 6)	2.3 V		20		MHz
				3 V		25		
				4.5 V		35		
Crosstalk (control input to signal output)	INH	COM or Y _n	C _L = 50 pF, R _L = 600 Ω, f _{in} = 1 MHz (square wave) (see Figure 7)	2.3 V		20		mV
				3 V		35		
				4.5 V		60		
Feedthrough attenuation (switch off)	COM or Y _n	Y _n or COM	C _L = 50 pF, R _L = 600 Ω, f _{in} = 1 MHz (see Note 7 and Figure 8)	2.3 V		–45		dB
				3 V		–45		
				4.5 V		–45		
Sine-wave distortion	COM or Y _n	Y _n or COM	C _L = 50 pF, R _L = 10 kΩ, f _{in} = 1 kHz (sine wave) (see Figure 9)	V _I = 2 V _{p-p}	2.3 V		0.1	%
				V _I = 2.5 V _{p-p}	3 V		0.1	
				V _I = 4 V _{p-p}	4.5 V		0.1	

NOTES: 6. Adjust f_{in} voltage to obtain 0-dBm output. Increase f_{in} frequency until dB meter reads –3 dB.
7. Adjust f_{in} voltage to obtain 0-dBm input.

operating characteristics, V_{CC} = 3.3 V, T_A = 25°C

PARAMETER	TEST CONDITIONS	TYP	UNIT
C _{pd} Power dissipation capacitance	C _L = 50 pF, f = 10 MHz	5.9	pF

PARAMETER MEASUREMENT INFORMATION

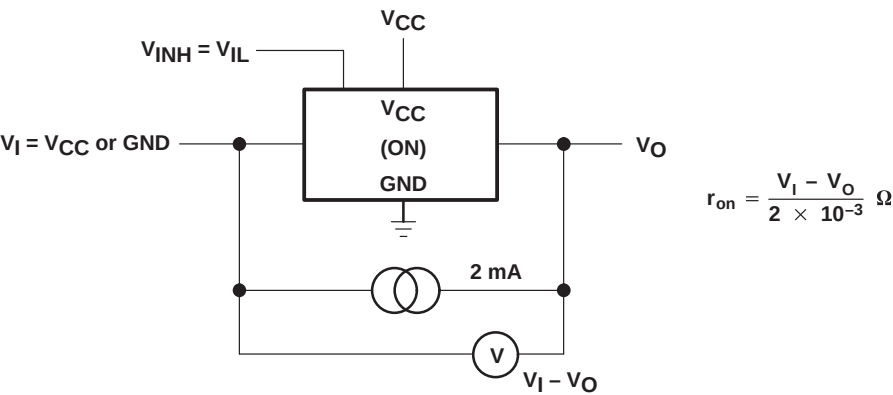


Figure 1. On-State Resistance Test Circuit

PARAMETER MEASUREMENT INFORMATION

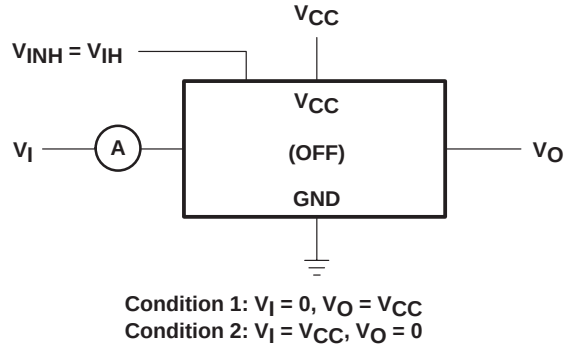


Figure 2. Off-State Switch Leakage-Current Test Circuit

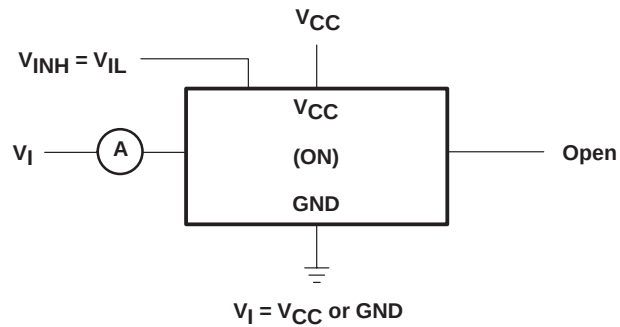


Figure 3. On-State Switch Leakage-Current Test Circuit

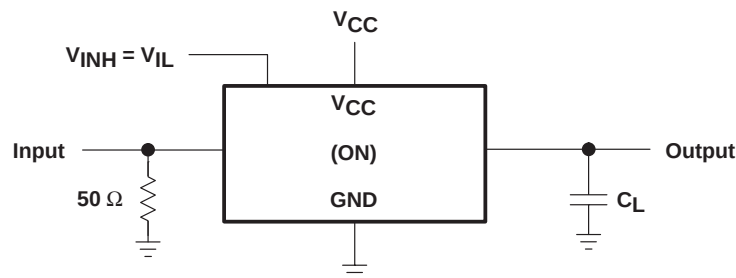


Figure 4. Propagation Delay Time, Signal Input to Signal Output

SN54LV4051A, SN74LV4051A 8-CHANNEL ANALOG MULTIPLEXERS/DEMULTIPLEXERS

SCLS428F – MAY 1999 – REVISED AUGUST 2003

PARAMETER MEASUREMENT INFORMATION

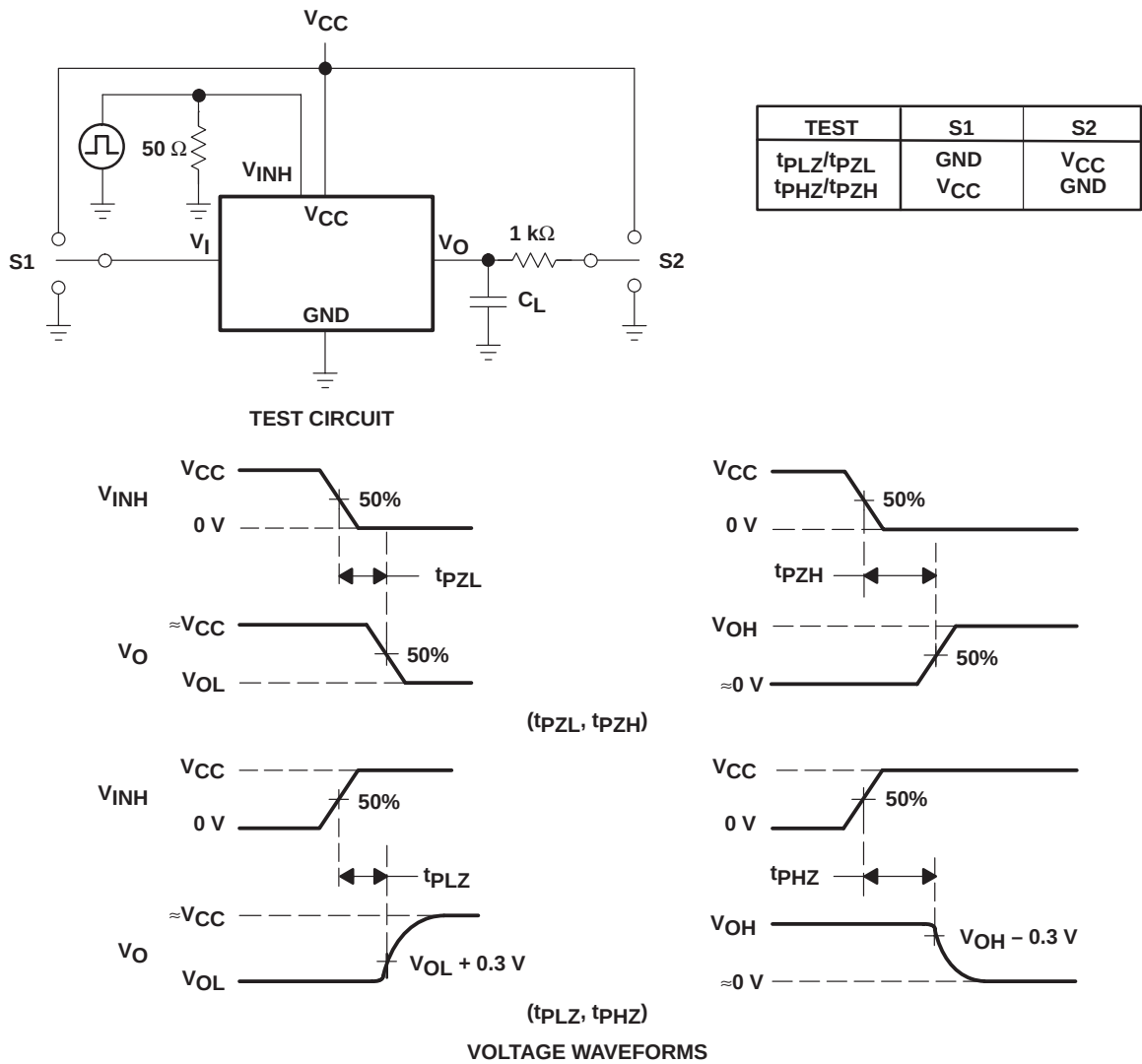
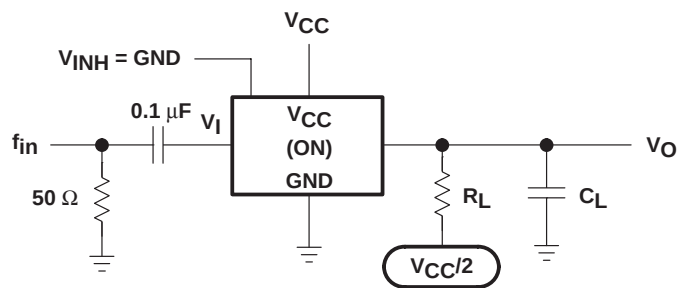


Figure 5. Switching Time (t_{pZL} , t_{pLZ} , t_{pZH} , t_{pHZ}), Control to Signal Output



NOTE A: f_{in} is a sine wave.

Figure 6. Frequency Response (Switch On)

PARAMETER MEASUREMENT INFORMATION

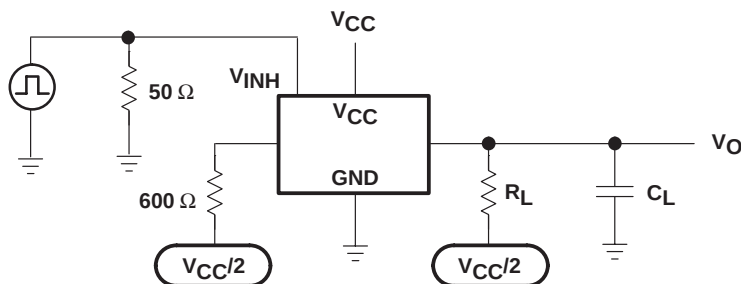


Figure 7. Crosstalk (Control Input, Switch Output)

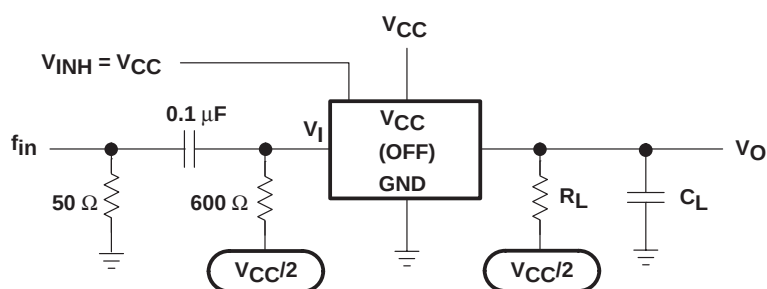


Figure 8. Feedthrough Attenuation (Switch Off)

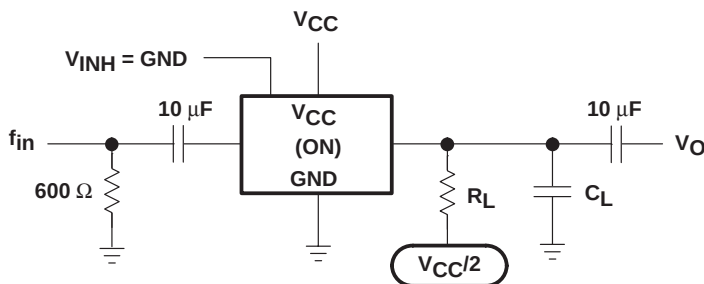
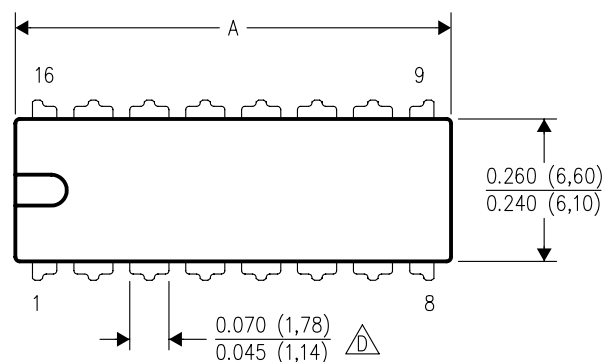


Figure 9. Sine-Wave Distortion

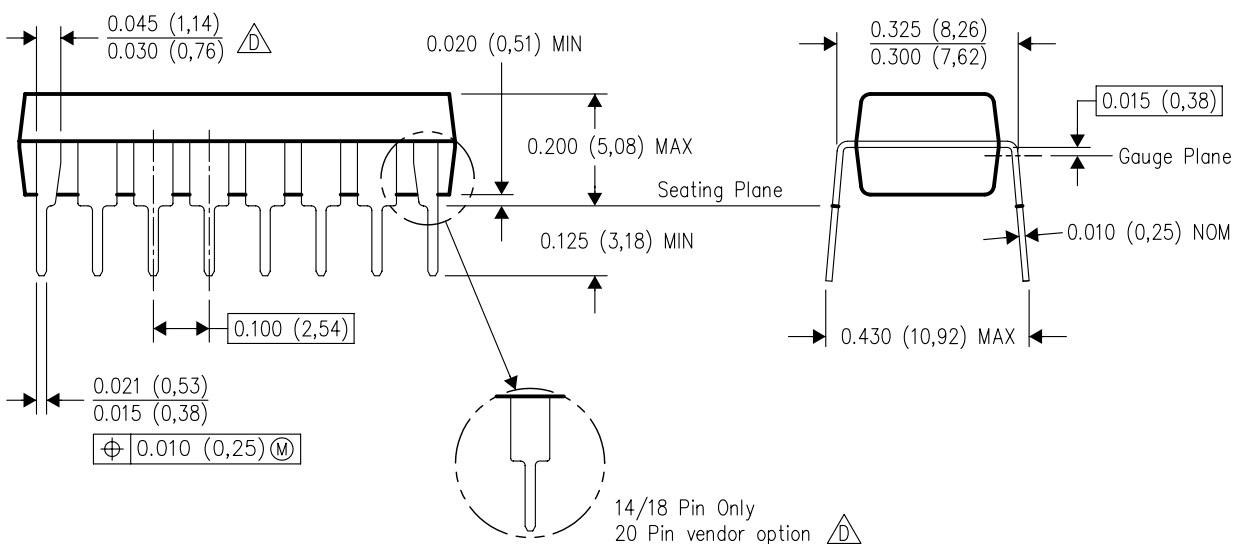
N (R-PDIP-T**)

16 PINS SHOWN

PLASTIC DUAL-IN-LINE PACKAGE



PINS ** DIM	14	16	18	20
A MAX	0.775 (19,69)	0.775 (19,69)	0.920 (23,37)	1.060 (26,92)
A MIN	0.745 (18,92)	0.745 (18,92)	0.850 (21,59)	0.940 (23,88)
MS-001 VARIATION	AA	BB	AC	AD



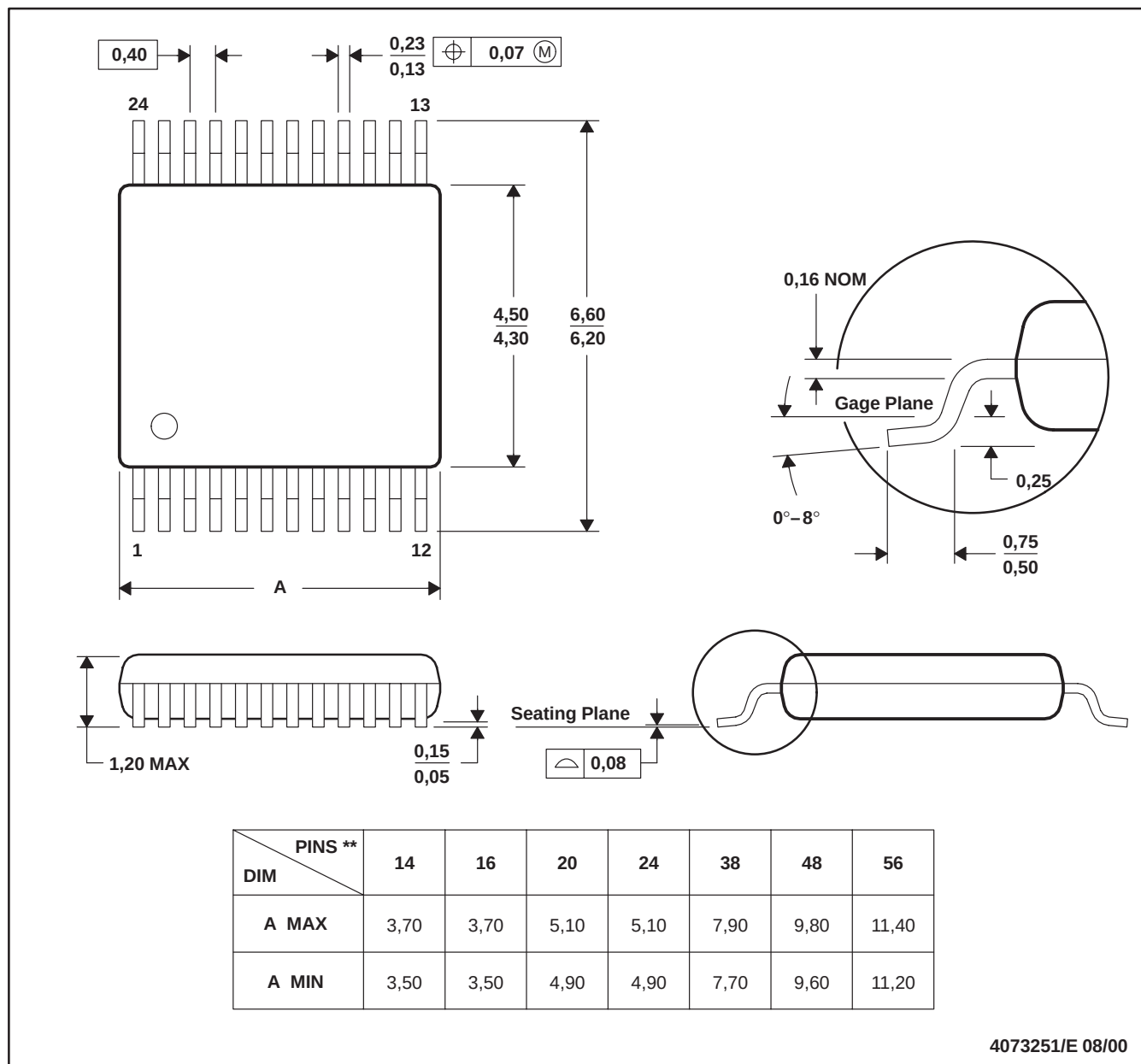
4040049/E 12/2002

- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 -  Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
 -  The 20 pin end lead shoulder width is a vendor option, either half or full width.

DGV (R-PDSO-G**)

PLASTIC SMALL-OUTLINE

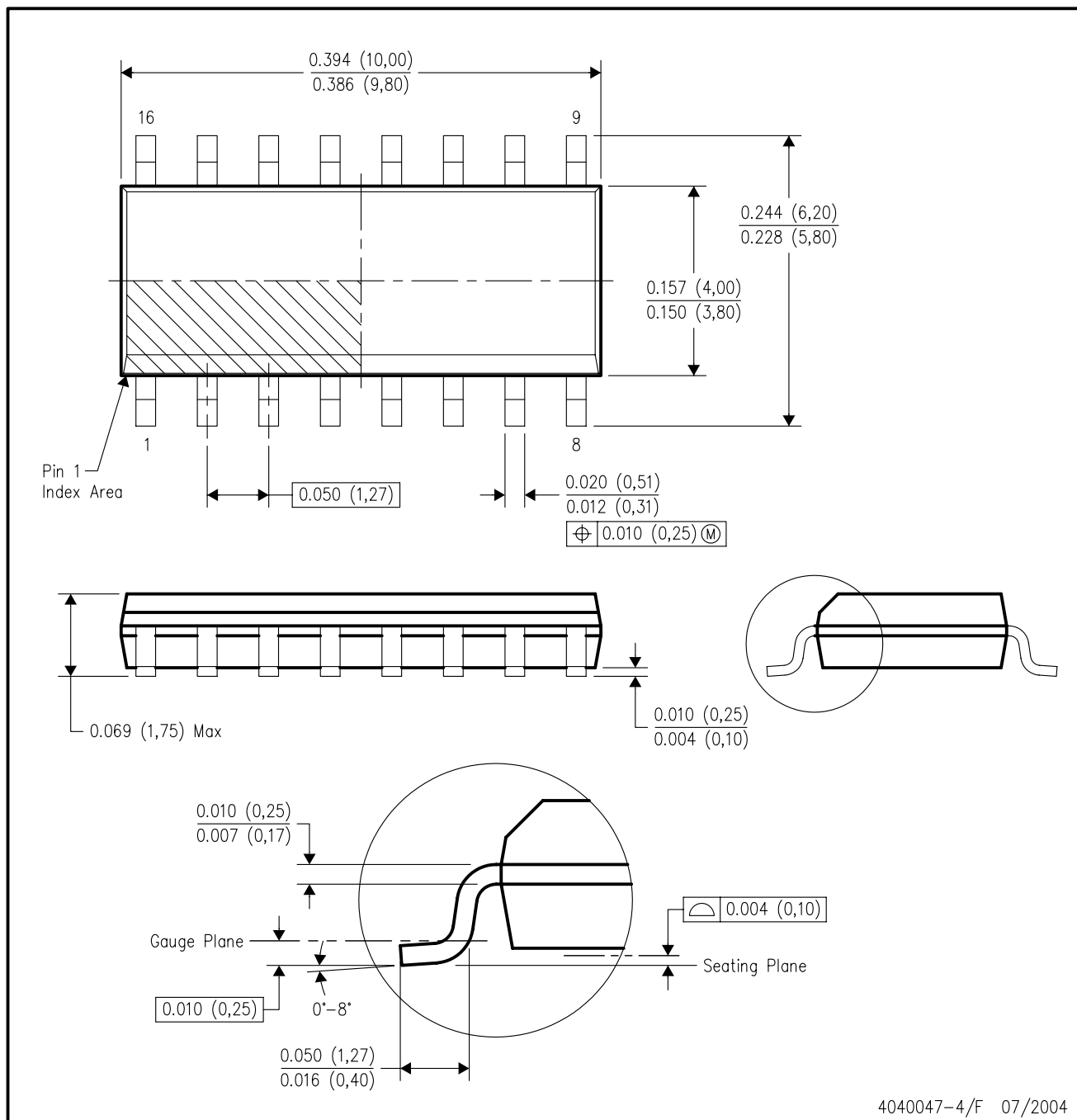
24 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.
 D. Falls within JEDEC: 24/48 Pins – MO-153
 14/16/20/56 Pins – MO-194

D (R-PDSO-G16)

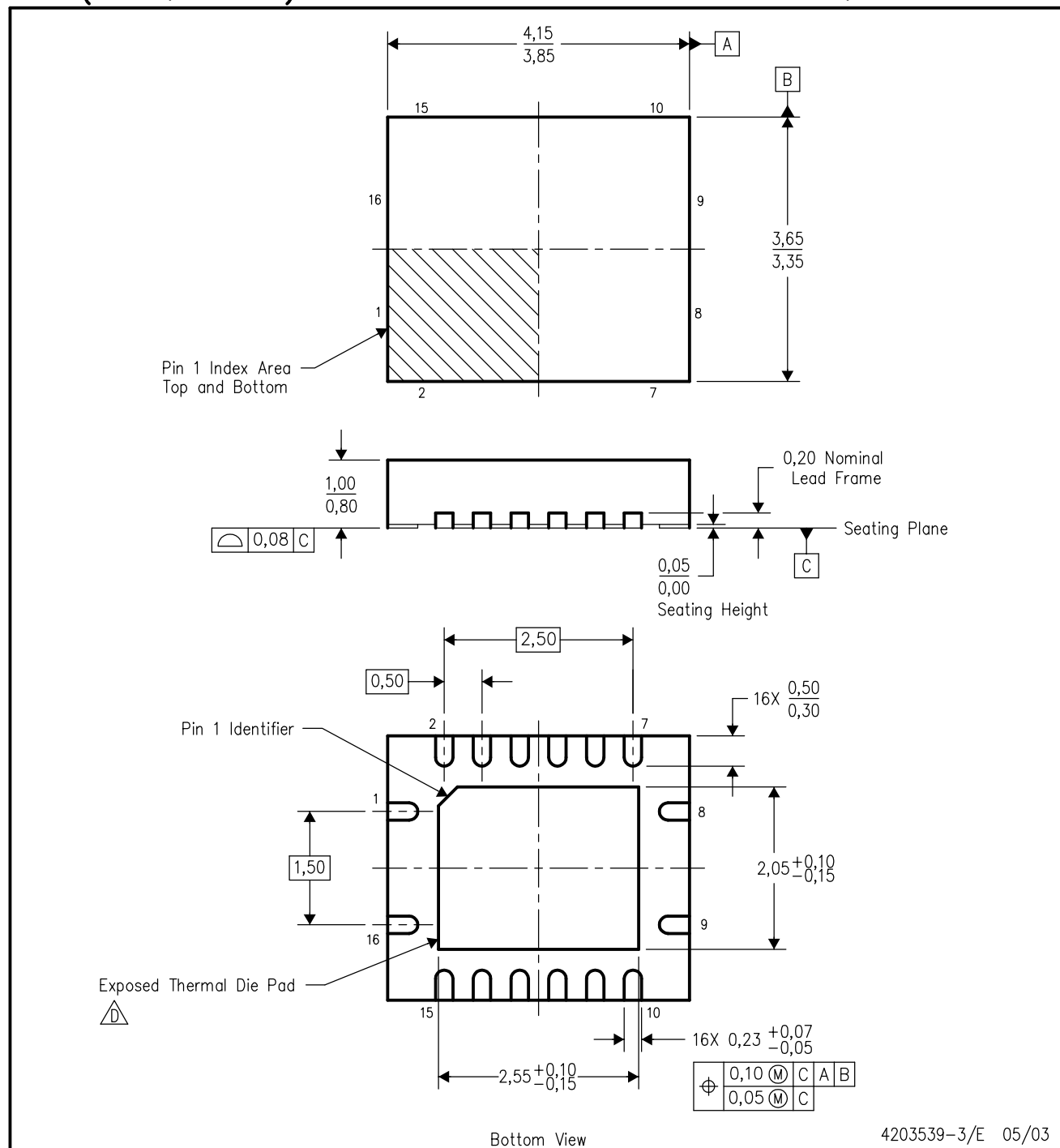
PLASTIC SMALL-OUTLINE PACKAGE



- NOTES:
- All linear dimensions are in inches (millimeters).
 - This drawing is subject to change without notice.
 - Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
 - Falls within JEDEC MS-012 variation AC.

RGY (R-PQFP-N16)

PLASTIC QUAD FLATPACK



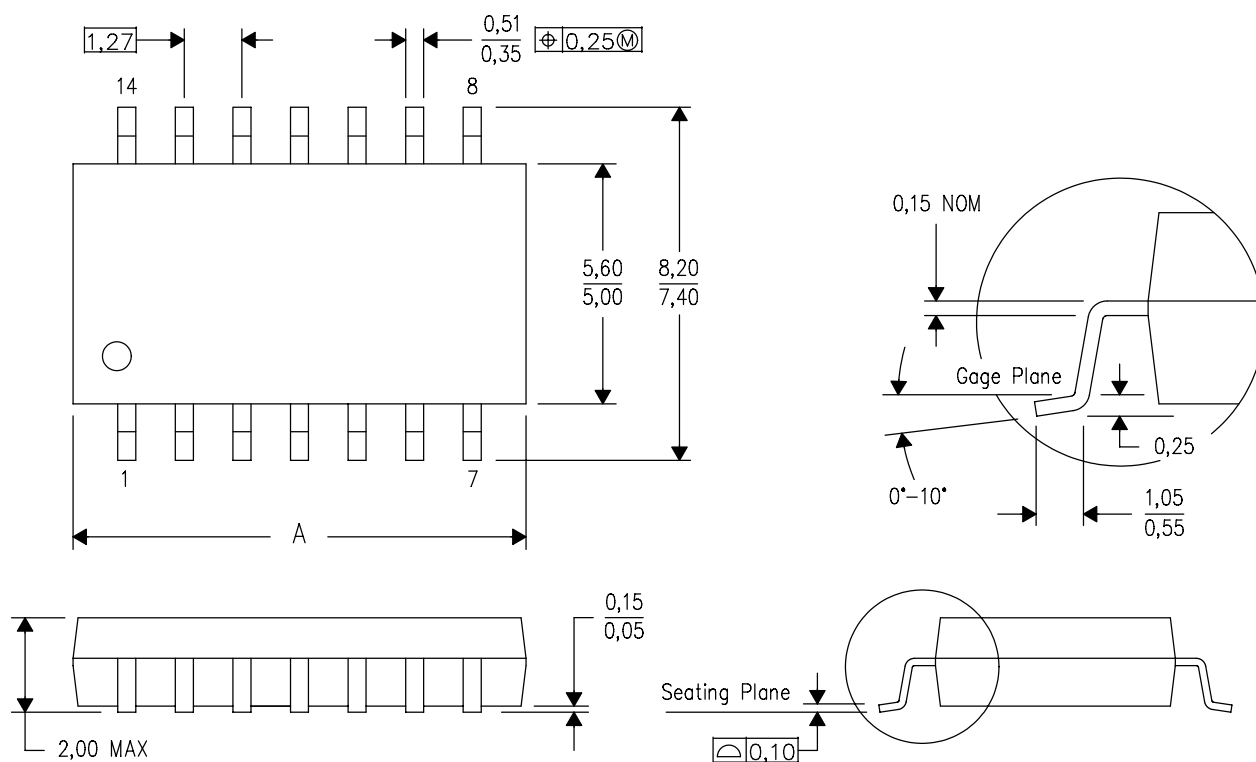
- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. QFN (Quad Flatpack No-Lead) package configuration.
 - The package thermal performance may be enhanced by bonding the thermal die pad to an external thermal plane. This pad is electrically and thermally connected to the backside of the die and possibly selected ground leads.
 - E. Package complies to JEDEC MO-241 variation BB.

MECHANICAL DATA

NS (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

14-PINS SHOWN



DIM \ PINS **	14	16	20	24
A MAX	10,50	10,50	12,90	15,30
A MIN	9,90	9,90	12,30	14,70

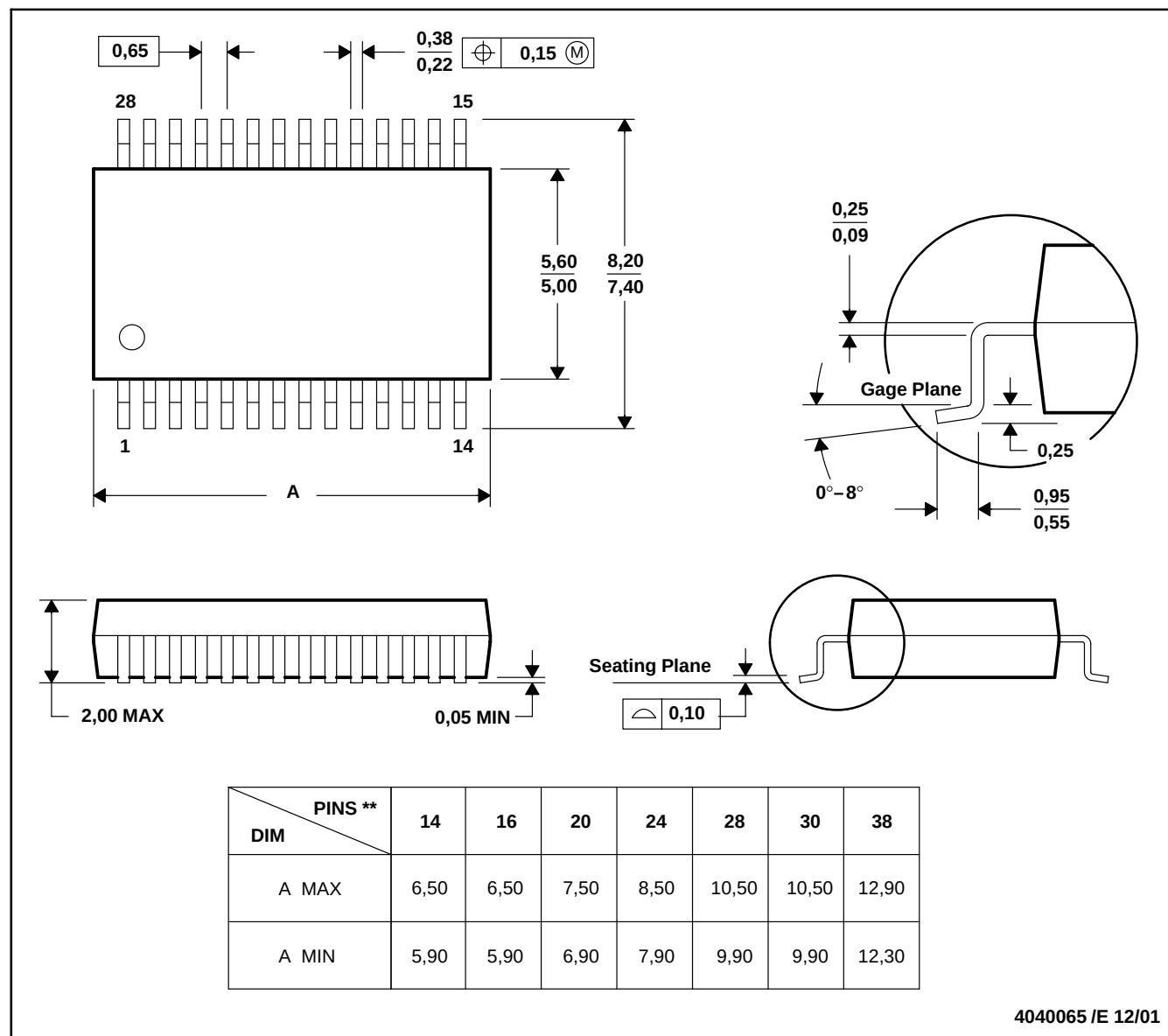
4040062/C 03/03

- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

DB (R-PDSO-G**)

PLASTIC SMALL-OUTLINE

28 PINS SHOWN

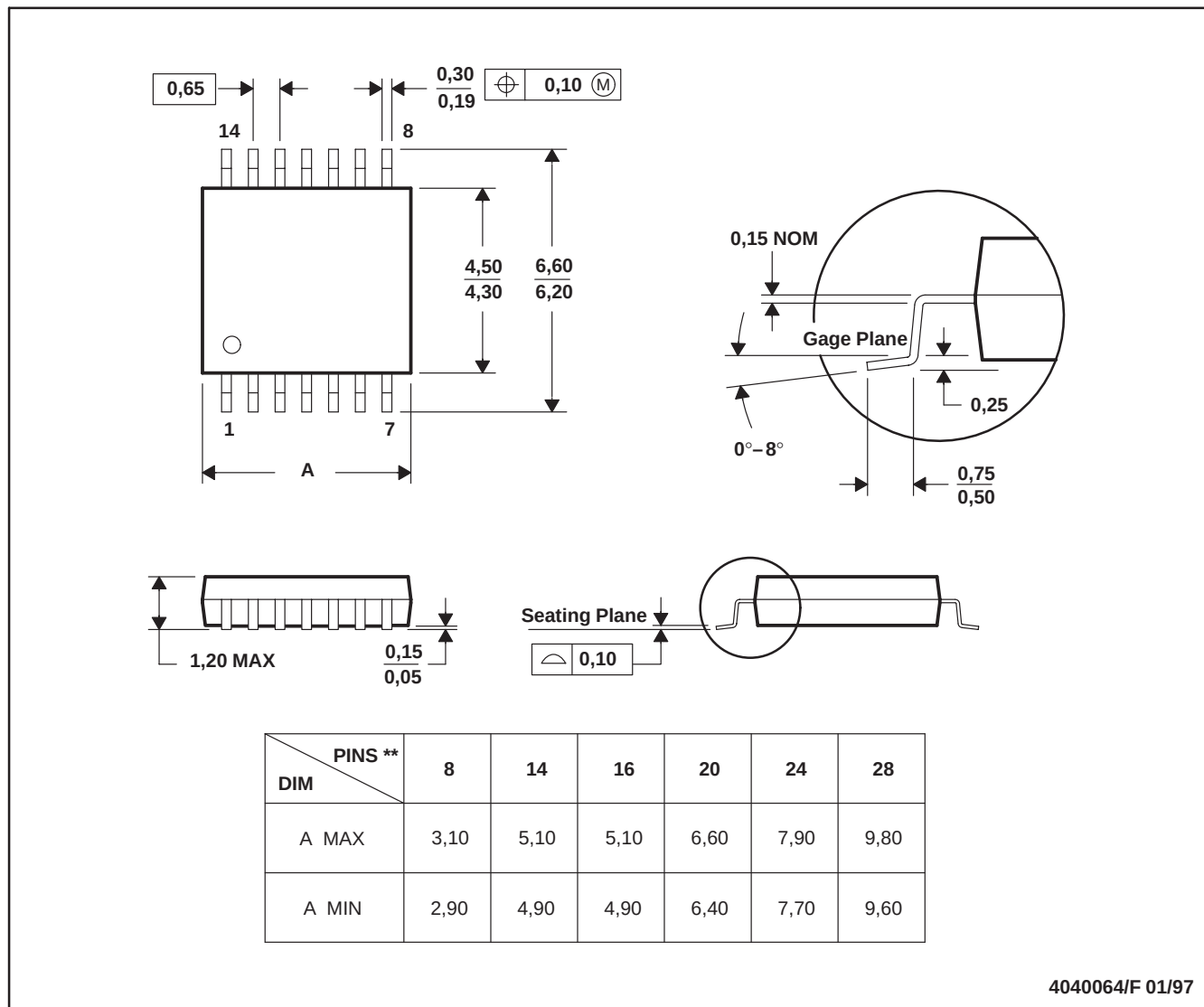


- NOTES: A. All linear dimensions are in millimeters.
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
 D. Falls within JEDEC MO-150

PW (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

14 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
 D. Falls within JEDEC MO-153

IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

Products		Applications	
Amplifiers	amplifier.ti.com	Audio	www.ti.com/audio
Data Converters	dataconverter.ti.com	Automotive	www.ti.com/automotive
DSP	dsp.ti.com	Broadband	www.ti.com/broadband
Interface	interface.ti.com	Digital Control	www.ti.com/digitalcontrol
Logic	logic.ti.com	Military	www.ti.com/military
Power Mgmt	power.ti.com	Optical Networking	www.ti.com/opticalnetwork
Microcontrollers	microcontroller.ti.com	Security	www.ti.com/security
		Telephony	www.ti.com/telephony
		Video & Imaging	www.ti.com/video
		Wireless	www.ti.com/wireless

Mailing Address: Texas Instruments
Post Office Box 655303 Dallas, Texas 75265

Copyright © 2004, Texas Instruments Incorporated